

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

ON Semiconductor NBXDDA016LN1TAG

For any questions, you can email us directly: sales@integrated-circuit.com



NBXDDA016, NBXDDB016

3.3 V, 133.33 MHz /137.93 MHz Dual Frequency CML Clock Oscillator

The NBXDDB016/NBXDDA016 dual frequency crystal oscillator (XO) is designed to meet today's requirements for 3.3 V CML clock generation applications. The device uses a high Q fundamental crystal and Phase Lock Loop (PLL) multiplier to provide selectable 133.33 MHz or 137.93 MHz, ultra low jitter and phase noise CML differential output.

This device is a member of ON Semiconductor's PureEdge[™] clock family that provides accurate and precision clock solutions.

Available in 5 mm x 7 mm SMD (CLCC) package on 16 mm tape and reel in quantities of 1,000. Frequency stability options available as either 50 PPM NBXDDB016 or 20 PPM NBXDDA016.

Features

- CML Differential Output
- Uses High Q Fundamental Mode Crystal and PLL Multiplier
- Ultra Low Jitter and Phase Noise 0.4 ps (12 kHz 20 MHz)
- Selectable Output Frequency 133.33 MHz (default)/137.93 MHz
- Hermetically Sealed Ceramic SMD Package
- RoHS Compliant
- Operating Range 3.3 V ±10%
- Total Frequency Stability ±20 PPM or ±50 PPM

Applications

- High-End Servers
- Basestation
- General Purpose Clock Generation and Margining

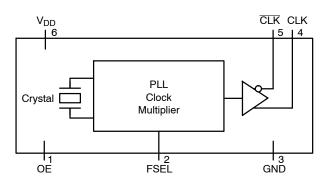


Figure 1. Simplified Logic Diagram



ON Semiconductor®

http://onsemi.com



6 PIN CLCC LN SUFFIX CASE 848AB

MARKING DIAGRAMS

NBXDDB016 133.33/137.93 AAWLYYWWG O



 NBXDDA016
 = NBXDDA016 (±50 PPM)

 NBXDDB016
 = NBXDDB016 (±20 PPM)

 133.33/137.93
 = Output Frequency (MHz)

 AA
 = Assembly Location

WL = Wafer Lot
YY = Year
WW = Work Week
G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping†
NBXDDB016LN1TAG*	CLCC-6 (Pb-Free)	1000/ Tape & Reel
NBXDDA016LN1TAG	CLCC-6 (Pb-Free)	1000/ Tape & Reel
NBXDDA016LNHTAG	CLCC-6 (Pb-Free)	100/ Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

^{*} Please contact sales office for availability

Distributor of ON Semiconductor: Excellent Integrated System Limited

Datasheet of NBXDDA016LN1TAG - IC OSC XTAL DUAL FREQ 6-CLCC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NBXDDA016, NBXDDB016

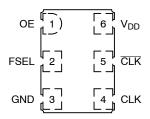


Figure 2. Pin Connections (Top View)

Table 1. PIN DESCRIPTION

Pin No.	Symbol	I/O	Description
1	OE	LVTTL/LVCMOS Control Input	Output Enable Pin. When left floating pin defaults to logic HIGH and output is active. See OE pin description Table 2.
2	FSEL	Control Input	Output Frequency Select Pin. Pin will default LOW when left open. See Output Frequency Select Table 3.
3	GND	Power Supply	Ground 0 V.
4	CLK	CML Output	Non–Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to V_{TT} = V_{DD} .
5	CLK	CML Output	Inverted Clock Output. Typically loaded with 50 Ω receiver termination resistor to $V_{TT} = V_{DD}$.
6	V_{DD}	Power Supply	Positive power supply voltage. Voltage should not exceed 3.3 V ±10%.

Table 2. OUTPUT ENABLE TRI-STATE FUNCTION

OE Pin	Output Pins
Open	Active
High Level	Active
Low Level	High Z

Table 3. OUTPUT FREQUENCY SELECT

FSEL Pin	Output Frequency (MHz)
Open (pin will float Low)	133.33
High Level	137.93
Low Level	133.33

Table 4. ATTRIBUTES

Characteristic		Value			
Input Default State Resistor		170 kΩ			
ESD Protection Human Body Model Machine Model		2 kV 200 V			
Meets or Exceeds JEDEC Standard EIA/JESD78 IC Latchup Test					

^{1.} For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

Table 5. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{DD}	Positive Power Supply	GND = 0 V		4.6	V
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-55 to +120	°C
T _{sol}	Wave Solder	See Figure 6		260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Distributor of ON Semiconductor: Excellent Integrated System Limited

Datasheet of NBXDDA016LN1TAG - IC OSC XTAL DUAL FREQ 6-CLCC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NBXDDA016, NBXDDB016

Table 6. DC CHARACTERISTICS (V_{DD} = $3.3~V \pm 10\%$, GND = 0~V, T_A = $-40^{\circ}C$ to $+85^{\circ}C$) (Note 2)

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
I _{DD}	Power Supply Current (Note 2)			70	100	mA
V_{IH}	OE Input HIGH Voltage		2000		V_{DD}	mV
V _{IL}	OE Input LOW Voltage		GND - 300		800	mV
I _{IH}	Input HIGH Current OE FSEL		-100 -100		+100 +100	μΑ
I _{IL}	Input LOW Current OE FSEL		-100 -100		+100 +100	μΑ
V _{IH}	FSEL Input HIGH Voltage		2000		V_{DD}	mV
V _{IL}	FSEL Input LOW Voltage		0		800	mV
V _{OH}	Output HIGH Voltage (Note 2)		V _{DD} -40		V_{DD}	mV
V _{OL}	Output LOW Voltage (Note 2)		V _{DD} -450	V _{DD} -380	V _{DD} -300	mV
V _{OUTPP}	Output Voltage Amplitude (Note 2)			380		mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Measurement taken with outputs terminated with 50 ohm to V_{DD} . See Figure 5.

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

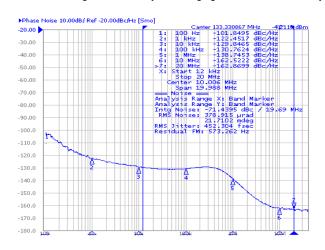
NBXDDA016, NBXDDB016

Table 7. AC CHARACTERISTICS (V_{DD} = 3.3 V \pm 10%, GND = 0 V, T_A = -40°C to +85°C) (Note 3)

Symbol	Characteristic	Conditions	Min.	Тур.	Max.	Units
f _{CLKOUT}	Output Clock Frequency	FSEL = HIGH		137.93		MHz
		FSEL = LOW		133.33		
Δf	Frequency Stability - NBXDDB016 - NBXDDA016	(Note 4)			±20 ±50	ppm
Φ_{NOISE}	Phase-Noise Performance	100 Hz of Carrier		-102		dBc/Hz
	f _{CLKout} = 133.33 MHz/137.93 MHz	1 kHz of Carrier		-120		dBc/Hz
	(See Figures 3 and 4)	10 kHz of Carrier		-126		dBc/Hz
		100 kHz of Carrier		-126		dBc/Hz
		1 MHz of Carrier		-134		dBc/Hz
		10 MHz of Carrier		-162		dBc/Hz
t _{jit} (Φ)	RMS Phase Jitter	12 kHz to 20 MHz		0.4	0.9	ps
t _{jitter}	Cycle to Cycle, RMS	1000 Cycles		1.5	8	ps
	Cycle to Cycle, Peak-to-Peak	1000 Cycles		10	30	ps
	Period, RMS	10,000 Cycles		0.8	4	ps
	Period, Peak-to-Peak	10,000 Cycles		7	20	ps
t _{OE/OD}	Output Enable/Disable Time				200	ns
t _{DUTY_CYCLE}	Output Clock Duty Cycle (Measured at Cross Point)		48	50	52	%
t _R	Output Rise Time (20% and 80%)			160	300	ps
t _F	Output Fall Time (80% and 20%)			160	300	ps
t _{start}	Start-up Time			1	5	ms
	Aging	1 st Year			3	ppm
		Every Year After 1st			1	ppm

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 3. Measurement taken with outputs terminated with 50 ohm to V_{DD} . See Figure 5.
- 4. Parameter guarantees 10 years of aging. Includes initial stability at 25°C, shock, vibration, and first year aging.





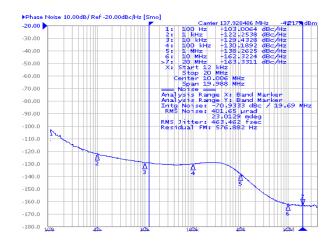


Figure 4. Typical Phase Noise Plot @ 137.93 MHz

NBXDDA016, NBXDDB016

Table 8. RELIABILITY COMPLIANCE

Parameter	Standard	Method	
Shock	Mechanical	MIL-STD-833, Method 2002, Condition B	
Solderability	Mechanical	MIL-STD-833, Method 2003	
Vibration	Mechanical	MIL-STD-833, Method 2007, Condition A	
Solvent Resistance	Mechanical	MIL-STD-202, Method 215	
Thermal Shock	Environment	MIL-STD-833, Method 1011, Condition A	
Moisture Level Sensitivity	Environment	MSL1 260°C per IPC/JEDEC J-STD-020D	

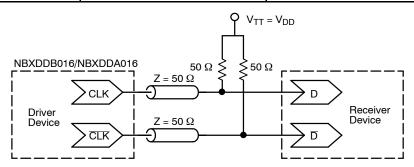


Figure 5. Typical CML Termination for Output Driver and Device Evaluation (See Application Note AND8173 – Termination of CML Devices)

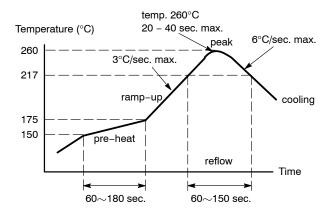


Figure 6. Recommended Reflow Soldering Profile

Distributor of ON Semiconductor: Excellent Integrated System Limited

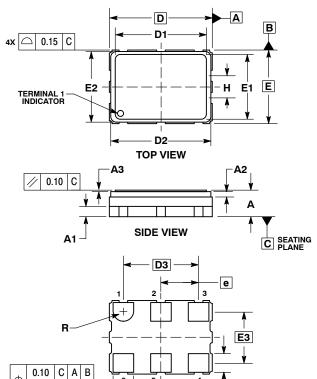
Datasheet of NBXDDA016LN1TAG - IC OSC XTAL DUAL FREQ 6-CLCC

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NBXDDA016, NBXDDB016

PACKAGE DIMENSIONS

6 PIN CLCC, 7x5, 2.54P CASE 848AB-01 **ISSUE C**

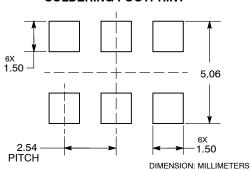


BOTTOM VIEW

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	1.70	1.80	1.90	
A1		0.70 REF		
A2		0.36 REF		
А3	0.08	0.10	0.12	
b	1.30	1.40	1.50	
D		7.00 BSC		
D1	6.17	6.20	6.23	
D2	6.66	6.81	6.96	
D3		5.08 BSC		
Е		5.00 BSC		
E1	4.37	4.40	4.43	
E2	4.65	4.80	4.95	
E3	3.49 BSC			
е	2.54 BSC			
L	1.17	1.27	1.37	
R	0.70 REF			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC products ould create a situation where personal injury or death may occur. Should be supported as the support of the science of the support of the support of the science of the support of the science of the support of the suppor associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

6X L

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

0.05 С 6X **b**

Literature Distribution Center for ON Semiconductor Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free

Phone: 421 33 790 2910 Japan Customer Focus Center

Phone: 81-3-5773-3850

Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative